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October 22, 2002

James R. Chiapetta, D.V.M. Scimed Life Systems, Inc. Patent Legal Department, Mail Station A150 One Scimed Place Maple Grove, MN 55311-1566

RECEIVED OCT 3 1 2002

TECHNOLOGY CENTER R3700

RE:

File No: **S63.2B-10010-US**

Title: Balloon With Improved Stent Retention and Intermittent

Coextrusion of Balloon Tubing

In Re: Robert Goodin, Robert Burgneier, Dan Horn, Edward

Parsonage and Paul J. Miller

Client File No.: 01-223 Associate File No.: Not Assigned

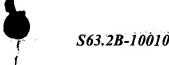
Dear Jim:

We have now completed the application for United States Letters Patent on the above-identified invention and are enclosing it, along with formal papers for your review and the inventors' review. After the inventors have thoroughly reviewed the application and formal papers, please have them execute the formal papers where indicated. Please have the inventors indicate their middle initials when signing the Declaration and Assignment documents.

In the event you or the inventors find errors, make corrections, or believe something has been omitted, please let us know immediately so that we may make revisions. If corrections are required, please do not execute the formal papers until the changes have been made and you have received the revised documents.

The application will be published unless you request, when filing the application, that the application not be published and certify that the application will not be foreign filed. If you do not wish the application to be published, please check the box below and sign and date the letter in the indicated space and return a copy of this letter to us. If you do not return a copy of this letter to us, we will assume that you consent to publication of the application.

James R. Chiapetta, D.V.M. October 22, 2002 Page 2



When the application is approved, please return the executed formal papers so that we may file the application with the Patent and Trademark Office.

JMU/jke Enclosu F:\wpwg	
	I do not currently plan to file the application in a foreign patent office and do not wish the application to be published. Please file a request for non-publication.
Signat	ture Date